SCAS317F - NOVEMBER 1993 - REVISED JUNE 1998

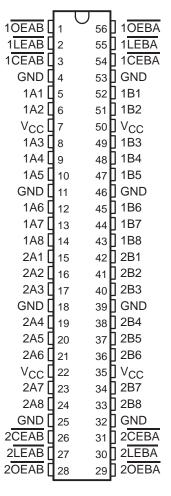
- **Member of the Texas Instruments** Widebus™ Family
- **EPIC™** (Enhanced-Performance Implanted **CMOS) Submicron Process**
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at V_{CC} = 3.3 V, T_A = 25°C
- **Power Off Disables Outputs, Permitting** Live Insertion
- **Supports Mixed-Mode Signal Operation on** All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883. Method 3015: Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per **JESD 17**
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 16-bit registered transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVCH16543A can be used as two 8-bit transceivers or one 16-bit transceiver. Separate latch-enable (LEAB or LEBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

DGG OR DL PACKAGE (TOP VIEW)



The A-to-B enable (CEAB) input must be low to enter data from A or to output data from B. If CEAB is low and LEAB is low, the A-to-B latches are transparent; a subsequent low-to-high transition of LEAB puts the A latches in the storage mode. With $\overline{\text{CEAB}}$ and $\overline{\text{OEAB}}$ both low, the 3-state B outputs are active and reflect the data present at the output of the A latches. Data flow from B to A is similar, but requires using the CEBA, LEBA, and OEBA inputs.

To ensure the high-impedance state during power up or power down, $\overline{\sf OE}$ should be tied to ${\sf V}_{\sf CC}$ through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.



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SN74LVCH16543A 16-BIT REGISTERED TRANSCEIVER WITH 3-STATE OUTPUTS

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description (continued)

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74LVCH16543A is characterized for operation from -40°C to 85°C.

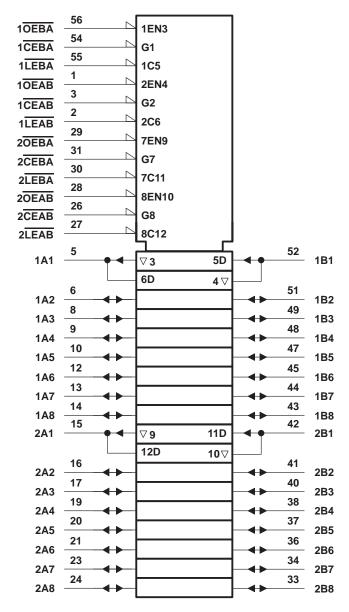
FUNCTION TABLE[†] (each 8-bit section)

	OUTPUT			
CEAB	LEAB	OEAB	Α	В
Н	Χ	Χ	Χ	Z
Х	Χ	Н	X	Z
L	Н	L	Χ	в ₀ ‡
L	L	L	L	L
L	L	L	Н	Н

[†] A-to-B data flow is shown; B-to-A flow control is the same except that it uses CEBA, LEBA, and OEBA.

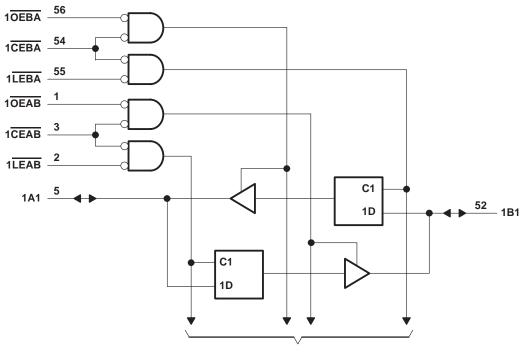
[‡] Output level before the indicated steady-state input conditions were established

logic symbol†

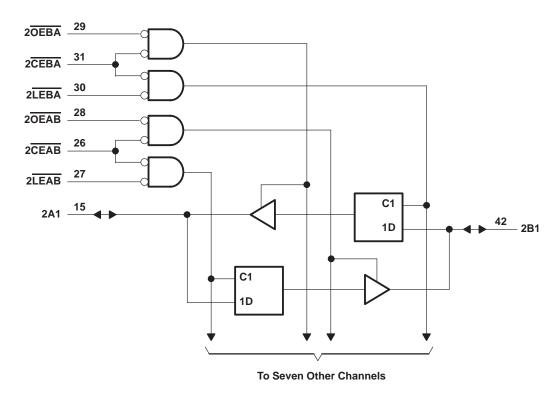


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



To Seven Other Channels





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

,	Supply voltage range, V _{CC}	–0.5 V to 6.5 V
-	Input voltage range, V _I : (see Note 1)	–0.5 V to 6.5 V
١	Voltage range applied to any output in the high-impedance or power-off state, VO	
	(see Note 1)	–0.5 V to 6.5 V
١	Voltage range applied to any output in the high or low state, VO	
	(see Notes 1 and 2)	. -0.5 V to V _{CC} + 0.5 V
- 1	Input clamp current, I _{IK} (V _I < 0)	
(Output clamp current, I _{OK} (V _O < 0)	–50 mA
(Continuous output current, IO	±50 mA
(Continuous current through each V _{CC} or GND	±100 mA
-	Package thermal impedance, θ_{JA} (see Note 3): DGG package	81°C/W
	DL package	74°C/W
,	Storage temperature range, T _{sto}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The value of V_{CC} is provided in the recommended operating conditions table.
- 3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
V	Cumhuyaltaga	Operating	1.65	3.6	V	
VCC	Supply voltage	Data retention only	1.5		v	
		V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}			
V_{IH}	High-level input voltage	V _{CC} = 2.3 V to 2.7 V	1.7		V	
		Voltage Operating Data retention only vel input voltage VCC = 1.65 V to 1.95 V	2			
		V _{CC} = 1.65 V to 1.95 V		0.35 × V _{CC}		
V_{IL}	Low-level input voltage	V _{CC} = 2.3 V to 2.7 V		0.7	V	
		V _{CC} = 2.7 V to 3.6 V		0.8		
٧ _I	Input voltage	-	0	5.5	V	
V _O	Output voltage	High or low state	0	Vcc	V	
		3 state	0	5.5	V	
		V _{CC} = 1.65 V		-4		
1	High level control compart	V _{CC} = 2.3 V		-8	mA	
ЮН	High-level output current	V _{CC} = 2.7 V		-12		
		V _{CC} = 3 V		-24		
		V _{CC} = 1.65 V		4		
la.	Lour lovel output ourrest	V _{CC} = 2.3 V		8	A	
IOL	Low-level output current	V _{CC} = 2.7 V		12	mA	
		V _{CC} = 3 V		24	1	
Δt/Δν	Input transition rise or fall rate		0	10	ns/V	
T _A	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



SN74LVCH16543A **16-BIT REGISTERED TRANSCEIVER WITH 3-STATE OUTPUTS**

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS	Vcc	MIN	TYPT MAX	UNIT	
		I _{OH} = -100 μA	1.65 V to 3.6 V	V _{CC} -0.2			
		I _{OH} = -4 mA	1.65 V	1.2		1	
PARAMETER VOH VOL II Control inputs Ioff II(hold) A or B ports IOZ¶ ICC	I _{OH} = -8 mA	2.3 V	1.7		V		
VOH		lau - 12 mA	2.7 V	2.2		ľ	
		I _{OH} = -12 mA	3 V	2.4]	
		I _{OH} = -24 mA	1.65 V to 3.6 V V _C 1.65 V 2.3 V 2.7 V 3 V 1.65 V to 3.6 V 1.65 V 2.3 V 2.7 V 3 V 2.7 V 3 V 2.3 V 2.7 V 3 V 2.7 V 3 V 2.7 V 3 V 2.7 V 3 V 3.6 V 0 1.65 V	2.2			
		I _{OL} = 100 μA	1.65 V to 3.6 V		0.2		
		I _{OL} = 4 mA	1.65 V		0.45		
VOL		I _{OL} = 8 mA	2.3 V		0.7	V	
		I _{OL} = 12 mA	2.7 V		0.4		
		I _{OL} = 24 mA	3 V		0.55		
Ц	Control inputs	$V_{I} = 0 \text{ to } 5.5 \text{ V}$	3.6 V	±5		μΑ	
l _{off}		V_I or $V_O = 5.5 V$	0		±10	μΑ	
	A or B ports	V _I = 0.58 V	1.65.\/	‡			
		V _I = 1.07 V	1.03 V	‡			
		V _I = 0.7 V	221/	45		μΑ	
I _I (hold)		V _I = 1.7 V	2.3 V	-45			
		V _I = 0.8 V	2 \/	75			
		V _I = 2 V	3 V	-75			
		$V_{I} = 0 \text{ to } 3.6 \text{ V}$	36 V		±500		
loz¶		$V_0 = 0 \text{ to } 5.5 \text{ V}$	3.6 V		±10	μΑ	
laa		$V_I = V_{CC}$ or GND	261/		20		
ICC		$3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}^{\text{\#}}$ $I_{\text{O}} = 0$	3.6 V		20	μΑ	
ΔlCC		One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND	2.7 V to 3.6 V		500	μА	
Ci	Control inputs	$V_I = V_{CC}$ or GND	3.3 V		5	pF	
C _{io}	A or B ports	$V_O = V_{CC}$ or GND	3.3 V		8	pF	

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

			V _{CC} = 1.8 V ± 0.15 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V	
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _W	Pulse duration, LE or CE low	‡		‡		3.3		3.3		ns
t _{su}	Setup time, data before LE or CE↓	‡		‡		1.1		1.1		ns
th	Hold time, data after LE or CE↓	‡		‡		1.9		1.9		ns

[‡] This information was not available at the time of publication.



[†] All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$. ‡ This information was not available at the time of publication.

[§] This is the bus-hold maximum dynamic current required to switch the input from one state to another.

[¶] For I/O ports, the parameter IOZ includes the input leakage current, but not I_{I(hold)}.

[#] This applies in the disabled state only.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 1.8 V ± 0.15 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
^t pd	A or B	B or A	†	†	†	†		6.1	1.2	5.4	ns
	LE	A or B	†	†	†	†		7.4	1.5	6.1	
t _{en}	CE	A or B	†	†	†	†		7.9	1.2	6.6	20
^t dis			†	†	†	†		7.1	1.5	6.6	ns
t _{en}		A or B	†	†	†	†		7.6	1	6.3	20
t _{dis}	ŌĒ		†	†	†	†		6.9	1.5	6.3	ns

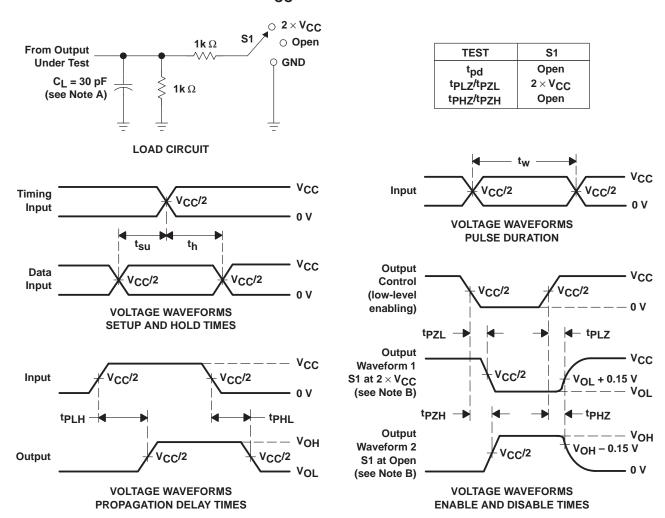
[†] This information was not available at the time of publication.

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	V _{CC} = 1.8 V ± 0.15 V	V _{CC} = 2.5 V ± 0.2 V	V _{CC} = 3.3 V ± 0.3 V	UNIT		
			CONDITIONS	TYP	TYP	TYP		
C _{pd}	Power dissipation capacitance	Outputs enabled	f = 10 MHz	†	†	44	ne l	
Сра	per transceiver	Outputs disabled	f = 10 MHz	†	†	4	pF	

[†] This information was not available at the time of publication.

PARAMETER MEASUREMENT INFORMATION $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$



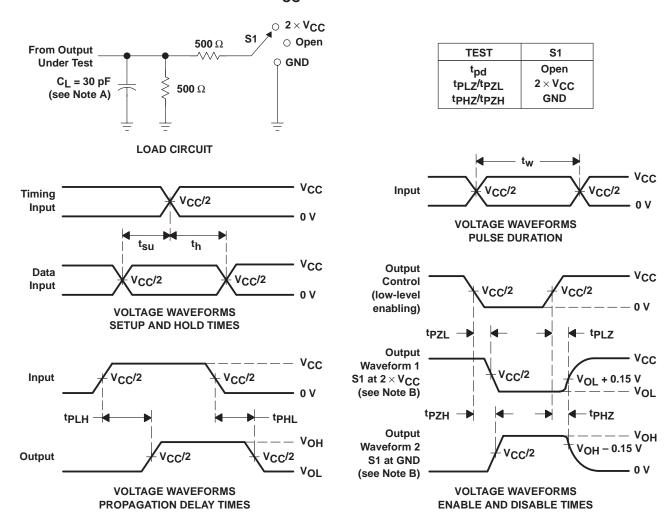
NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq 2$ ns. $t_f \leq 2$ ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzl and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

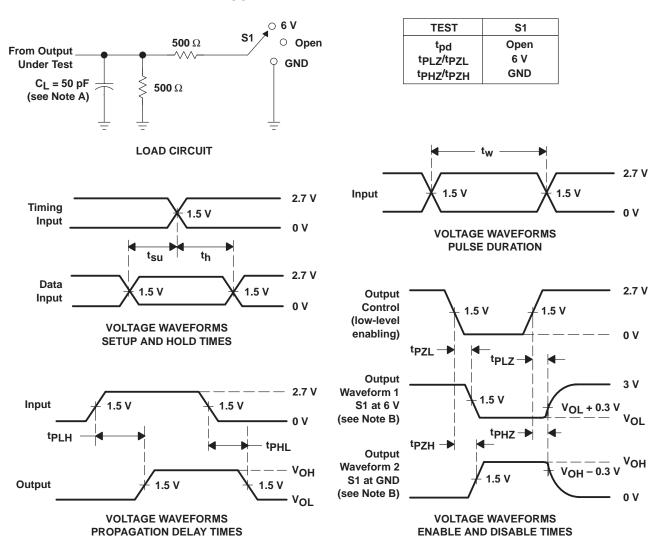


NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq 2$ ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION V_{CC} = 2.7 V AND 3.3 V \pm 0.3 V



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_{O} = 50 \Omega$, $t_{f} \leq$ 2.5 ns, $t_{f} \leq$ 2.5 ns,
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms



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